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ON Semiconductor®

FDS4465-F085

P-Channel 1.8V Specified PowerTrench MOSFET

General Description

This P-Channel 1.8V specified MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (1.8V - 8V).

Applications

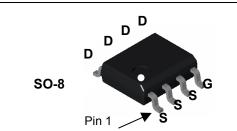
- Power management
- Load switch
- Battery protection

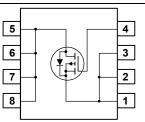


Features

 $\label{eq:rescaled} \begin{array}{l} \bullet \ -13.5 \ \text{A}, \ -20 \ \text{V}. & R_{\text{DS}(\text{ON})} = 8.5 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -4.5 \ \text{V} \\ & R_{\text{DS}(\text{ON})} = 10.5 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -2.5 \ \text{V} \\ & R_{\text{DS}(\text{ON})} = 14 \ \text{m} \Omega \ \textcircled{0} \ \text{V}_{\text{GS}} = -1.8 \ \text{V} \end{array}$

- Fast switching speed
- High performance trench technology for extremely low R_{DS(ON)}
- High current and power handling capability
- Qualified to AEC Q101
- RoHS Compliant





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current – Continuous	(Note 1a)	-13.5	A
	- Pulsed		-50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	85	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

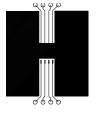
Package Marking and Ordering Information

	Device Marking	Device	Reel Size	Tape width	Quantity
	FDS4465	FDS4465-F085	13"	12mm	2500 units
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Publication Order Number: FDS4465-F085/D

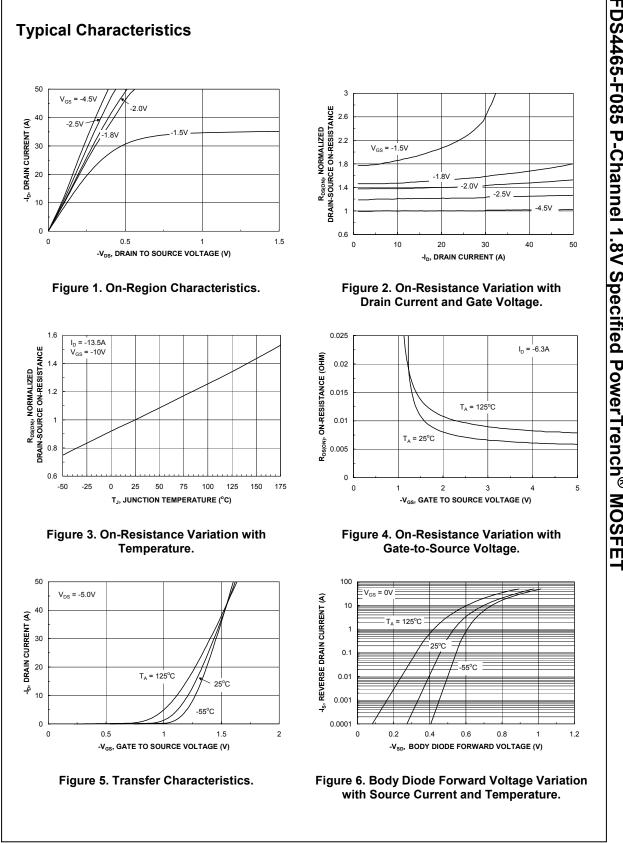
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, I_D = -13.5 \ A \\ V_{GS} = -2.5 \ V, I_D = -12 \ A \\ V_{GS} = -1.8 \ V, I_D = -10.5 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -13.5 \ A, \ T_J = 125^{\circ} C \end{array} $		6.7 8.0 9.8 9.0	8.5 10.5 14 13	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-50			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -13.5 A$		70		S
	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		8237		pF
	Output Capacitance	$v_{DS} = -10 v$, $v_{GS} = 0 v$, f = 1.0 MHz		1497		pF
C _{rss}	Reverse Transfer Capacitance			750		pF
	·					
	Turn–On Delay Time	$V_{DD} = -10V, I_D = -1 A,$		20	36	ns
t _{d(on)} t _r	Turn–On Rise Time	$V_{DD} = -10V$, $I_D = -1A$, $V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$		20	38	ns
t _{d(off)}	Turn–Off Delay Time			300	480	ns
t _f	Turn–Off Fall Time	-		140	224	ns
- Q _g	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -13.5 A$,		86	120	nC
Q _{qs}	Gate–Source Charge	$V_{GS} = -4.5 V$		20		nC
Q _{gd}	Gate–Drain Charge	-		11		nC
Drain_9	ource Diode Characteristics	and Maximum Patings	L	L		1
	Maximum Continuous Drain–Source				-2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -2.1 A$ (Note 2)		-0.6	-1.2	V



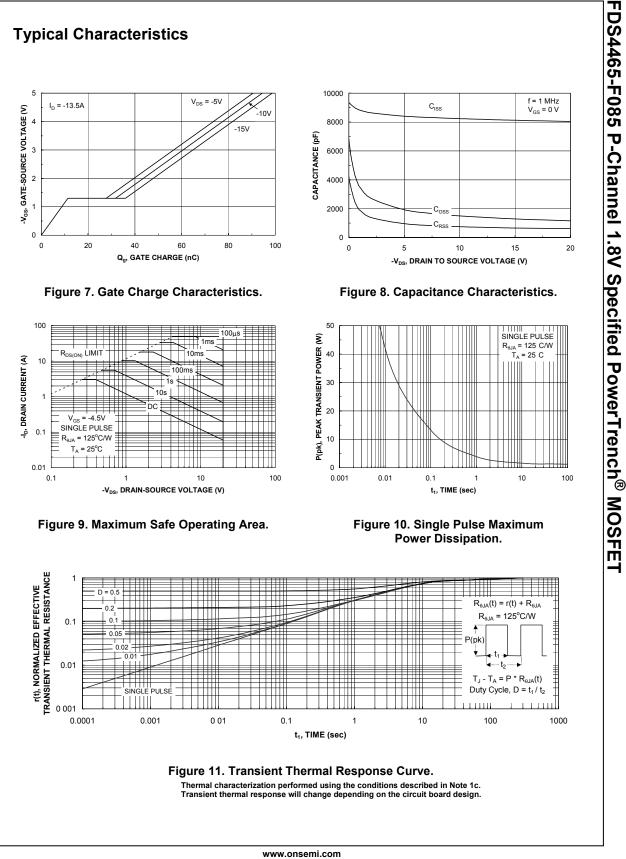
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

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FDS4465-F085 P-Channel 1.8V Specified PowerTrench[®] MOSFET



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